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Electrical conductivity

Ohms Law

Resistivity, p:

-- a material property that is independent of sample size and

geometry

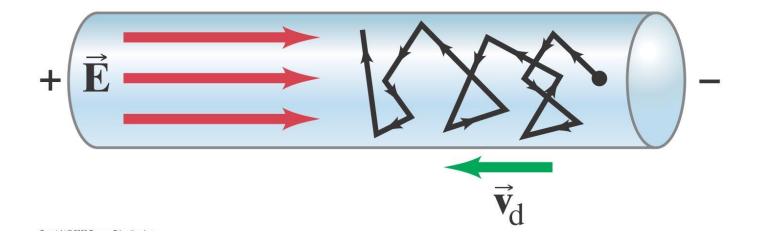
surface area of current flow current flow path length

Conductivity, s

$$\sigma = \frac{1}{\rho}$$



Drift Velocity



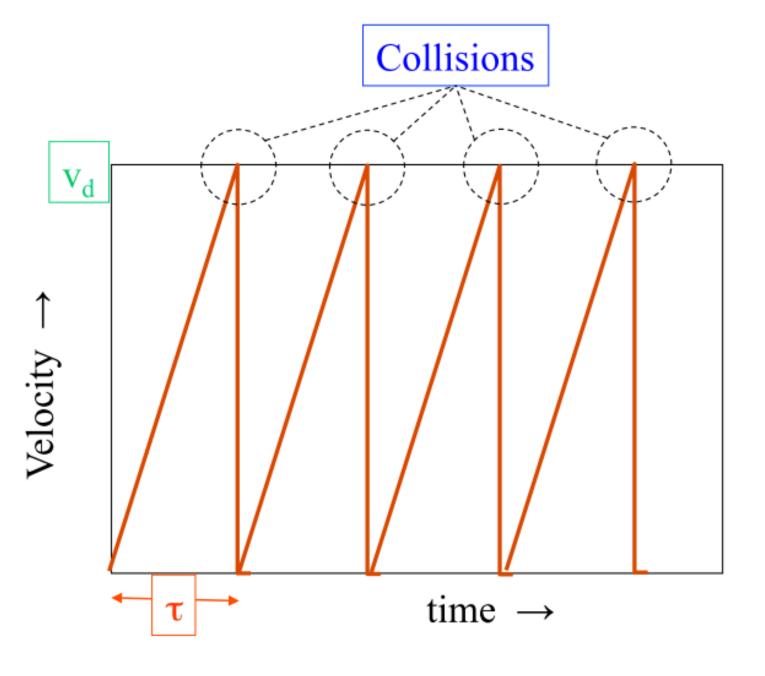
• When the E-Field is first applied, the electrons initially accelerate but soon reach a more or less steady state average velocity.

 This average velocity is in the direction opposite of the E-Field and is known drift velocity

 Drift velocity is due to electrons colliding with metal atoms in the conductor



Drift velocity



Force experienced by an electron

$$F = ma = \vec{E}e$$

 $m \rightarrow mass of an electron$

E → applied electric field

$$F = m \left(\frac{V_d}{\tau} \right) = E.e$$

$$V_d = \frac{Ee\tau}{m}$$

V_d = Average drift velocity

 τ = average collision time

Av. electron velocity in the direction of force imposed by the applied field.



Average electron velocity in the direction of force imposed by the applied field.

$$V_{d} \propto E$$

proportionality constant = electron mobility.

$$V_d = \mu_e E$$

 μ_e is an indication of the frequency of the scattering events; Its unit is m²/V.s

$$\vec{J} = ne\vec{V}_d \quad \text{and} \quad \vec{J} = \sigma \vec{E} \quad \Rightarrow \quad \sigma = ne\mu$$

$$\sigma = ne\mu$$

$$\sigma = \frac{ne^2\tau}{m}$$



Mean free path of electron

Average distance between two successive collisions (With electric field)

For an ideal crystal

- 1. At temperature T = 0 K, mean free path = $\infty \rightarrow$ infinite conductivity
- 2. At temperature T > 0 K
- Atoms vibrate about their mean positions
- these vibrations can be thought of as elastic waves in crystals (phonons)
- these phonons interact with the motion of electrons
 - → decrease in conductivity



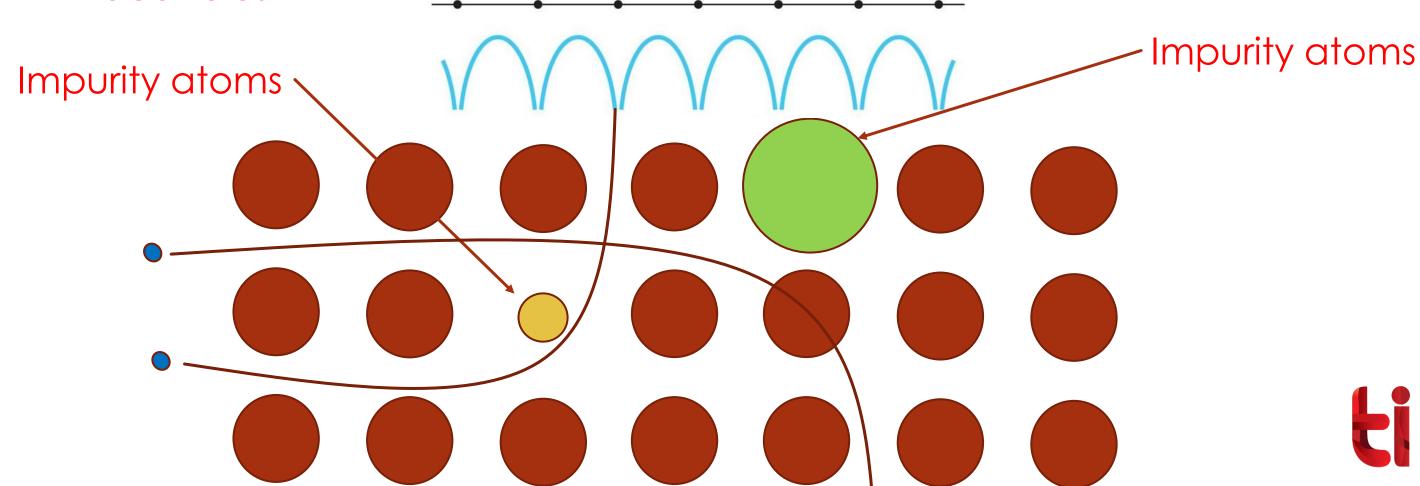
Metals: Influence of Temperature and Impurities on Resistivity

Presence of imperfections (Scattering centers) increases resistivity



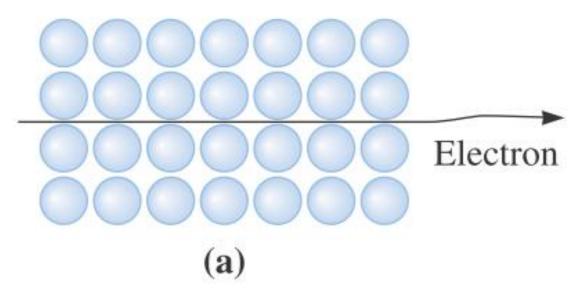
- -- dislocations
- -- impurity atoms
- -- vacancies

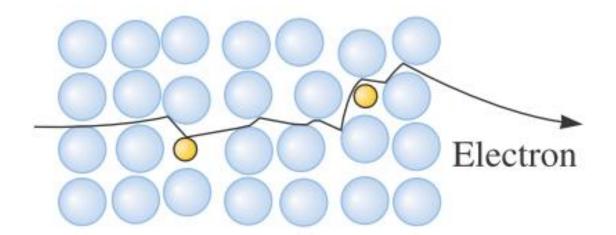
These act to scatter electrons so that they take a less direct path.



Scattering of electrons

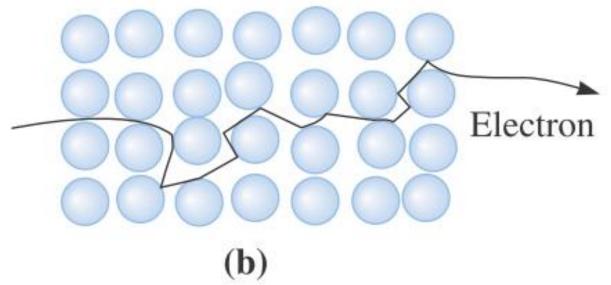
Perfect crystal





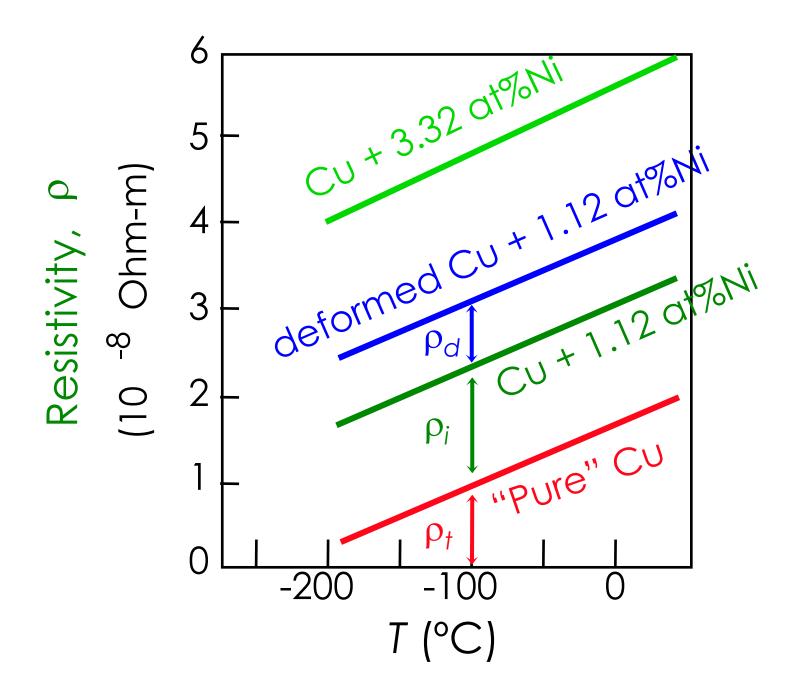
A crystal with atomic level defects







Metals: Influence of Temperature and Impurities on Resistivity



- Resistivity increases with:
 - -- temperature
 - -- wt% impurity
 - -- % Deformation

$$\rho = \rho_{\text{thermal}} \\
+ \rho_{\text{impurity}} \\
+ \rho_{\text{deformation}}$$



For electrical contacts

- 1. High electrical conductivity
- 2. High thermal conductivity dissipate heat effectively
- 3. High melting point accidental overheating does not fuse the contacts
- 4. High oxidation resistance free from insulating oxides
- High mechanical strength- For critical contacts. Al strength increases by CdO dispersion. Dislocation do not moveductility decreases.

Ex: Al for long distance applications & Cu for switch, brushes, relays, etc.



As a conductor in transmission and distribution lines

- 1. Low I^2R loss (Power)
- 2. Copper and Al best choices.
- 3. Large cross section area to reduce loss.
- 4. Al by reinforcing steel gives better strength.



As a resistor

- 1. Uniform resistivity
- 2. Stable resistance
- 3. Low thermoelectric potential with Cu
- 4. Small temperature coefficient of resistance (α)
 - → (minimizes error due to fluctuations in temp)

$$\alpha = \frac{1}{R} \frac{dR}{dT}$$

For pure Cu, $\alpha = 4000 \times 10^{-6} \text{ K}^{-1}$,

Manganin alloy (87 % Cu, 13 % Mn) $\alpha = 20 \times 10^{-6} \text{ K}^{-1}$

E.g. Ballast Resistor: used to maintain constant current in industrial circuits.

Flow of current increases \rightarrow Temp increases \rightarrow Resistance increases \rightarrow decreases current in the circuit \rightarrow Fault.



As a heating element

- 1. High melting point
- 2. High resistivity
- 3. Good oxidation resistance
- 4. Good creep strength
- 5. Resistance to thermal fatigue
 - → Low elastic modulus
 - → Low thermal expansion

Candidates

- a. Nichrome (80%NI,20%Cr)
- b. Kanthal (69%Fe, 23%Cr, 6%Al, 2%Co)
- c. SiC
- d. MoSi₂
- e. Graphite for inert atmosphere
- f. Mo, Ta: Poor oxidation resistance
- g. W: ThO₂ dispersion to improve creep resistance



As a thermometer

- 1. High temperature coefficient of resistance (α)
- 2. Should changes linearly with temperature

Candidate: Pure metal e.g. Pt



- 1. A velocity of electron in the presence of electric field is known as drift velocity.
- 2. Conductivity is directly proportional to the mobility of electrons.
- 3. Electrical conductivity is strongly affected by impurity, defects and grain boundaries.
- 4. At 0 K the ideal crystal has infinite conductivity, which decreases with increases in the temperature due to atomic vibrations.

